

**PATENT ASSIGNMENT**

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Karl-Heinz Allers	05/02/2006
Reiner Schwab	05/09/2006
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Infineon Technologies AG
<b>Street Address:</b>	St.-Martin-Strasse 53
<b>City:</b>	Muenchen
<b>State/Country:</b>	GERMANY
<b>Postal Code:</b>	81669
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	11408794
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(972)732-9218
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	972-732-1001
<b>Email:</b>	russell@slater-matsil.com
<b>Correspondent Name:</b>	Slater & Matsil, L.L.P.
<b>Address Line 1:</b>	17950 Preston Rd.
<b>Address Line 2:</b>	Suite 1000
<b>Address Line 4:</b>	Dallas, TEXAS 75252
<b>ATTORNEY DOCKET NUMBER:</b>	2003 P 53196 US (LSS)
<b>NAME OF SUBMITTER:</b>	Ira S. Matsil
<b>Total Attachments: 2</b>	
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CH \$40.00 11408794

### ASSIGNMENT

For good and valuable consideration, I, **Karl-Heinz Allers**, residing at Heisenbergweg 38, 85540 Haar, Germany, a citizen of Germany; **Reiner Schwab**, residing at Seisersberger Strasse 18, 83734 Hausham, Germany, a citizen of Germany;

hereby sell, assign, and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Strasse 53, Muenchen, 81669, Germany;

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewithin, and is entitled:

#### **Capacitor Arrangement in a Semiconductor Component and Driving Apparatus**

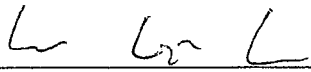
and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent

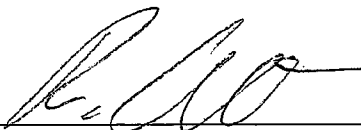
protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 2.17.06

  
Karl-Heinz Allers

Date: 9.5.06

  
Reiner Schwab